

2N2876  
SILICON N-P-N PLANAR TRANSISTOR

Maximum Ratings, Absolute-Maximum Values

COLLECTOR-TO-BASE VOLTAGE, $V_{CB0}$ . . .	80
COLLECTOR-TO-EMITTER VOLTAGE, $V_{CE0}$ . . .	60
With base open, $V_{CE0}$ . . .	60
With $V_{BE} = -1.5$ volts, $V_{CEV}$ . . .	80
EMITTER-TO-BASE VOLTAGE, $V_{EB0}$ . . .	4
COLLECTOR CURRENT, $I_C$ . . .	2.5
TRANSISTOR DISSIPATION, $P_T$ . . .	17.5
At case } up to 25°C	Derate linearly 100mW/°C
temperatures } above 25°C	

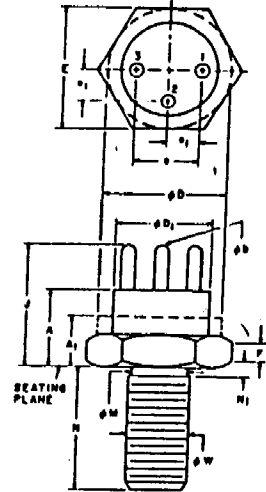
TEMPERATURE RANGE:			
Storage . . . . .	-65to+200	-65to+200	°C
Operating (Junction) . . . . .	-65to+200	-65to+200	°C
LEAD TEMPERATURE (during soldering):			
At distances $\geq 1/32"$ from ceramic wafer for 10 sec. max. . . . .	230	max.	°C
At distances $\geq 1/32"$ from seating surface for 10 sec. max. . . . .	230	max.	°C

ELECTRICAL CHARACTERISTICS Case Temperature = 25° C Unless Otherwise Specified

Characteristic	Symbol	TEST CONDITIONS						LIMITS		Units
		DC Collector Volts		DC Base Volts	DC Current (Milliamperes)			2N2876		
		$V_{CB}$	$V_{CC}$	$V_{BE}$	$I_E$	$I_B$	$I_C$	Min.	Max.	
Collector-Cutoff Current	$I_{CBO}$	30			0			-	0.1	$\mu A$
Collector-to-Base Breakdown Voltage	$BV_{CBO}$				0		0.5	80	-	volts
Collector-to-Emitter Breakdown Voltage (Sustaining)	$BV_{CEO(sus)}$				0	500 <sup>a</sup>		60	-	volts
Collector-to-Emitter Breakdown Voltage	$BV_{CEV}$			-1.5		0.1		80	-	volts
Emitter-to-Base Breakdown Voltage	$BV_{EB0}$				0.1			4	-	volts
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$				300	1.5 amp		-	-	volt
					500	2.5 amp		-	1	volt
Feedback Capacitance (Measured at 140 Kc)	$C_{b'c}$	30			0			-	20	pf
RF Power Output, Unneutralized	$P_{out}$									watts
Measured at 50 Mc			28			500	10 <sup>a</sup>	-	-	watts
50 Mc			28			375	-	-	-	watts
150 Mc			28			275	3 <sup>b</sup>	-	-	watts
Gain-Bandwidth Product	$f_T$		28			250		200 (typ.)		Mc
Base Spreading Resistance (Measured at 400 Mc)	$r_{bb'}$		28			250		6.0 (typ.)		ohms
Collector-to-Case Capacitance	$C_C$							-	8	pf

<sup>a</sup> Pulsed. Pulse duration  $\leq 5 \mu sec$ ; duty factor  $\leq 1\%$ .  
<sup>b</sup> For  $P_{IN} = 2$  watts.  
<sup>c</sup> For  $P_{IN} = 1$  watt.

TO-60



SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	0.215	0.320	5.46	8.13	
A <sub>1</sub>	-	0.105	-	4.19	2
$\phi B$	0.030	0.045	0.762	1.17	4
$\phi D$	0.390	0.437	9.14	11.10	2
$\phi D_1$	0.320	0.360	8.13	9.14	
E	0.424	0.437	10.77	11.10	
e	0.100	0.215	4.70	5.46	
f	0.090	0.110	2.29	2.79	
F	0.090	0.138	2.29	3.43	1
J	0.395	0.400	9.92	10.16	
$\phi M$	0.163	0.169	4.14	4.30	
N	0.375	0.405	9.53	10.28	
N <sub>1</sub>	-	0.075	-	1.90	
$\phi W$	0.160	0.167	4.127	4.310	3, 5

MILLIMETER DIMENSIONS ARE DERIVED FROM ORIGINAL INCH DIMENSIONS

NOTES:

- Dimension does not include seating flange
- Package outline optional within dimensions specified
- Pitch diameter - 10-32 UNF 8A thread (coated)
- Pin spacing permits insertion in any socket having a pin-circle diameter of 0.200 in. (5.08 mm) and sockets which will accommodate pins with a diameter of 0.030 in. (0.762 mm) min., 0.045 in. (1.17 mm) max.
- The torque applied to a 10-32 hex nut assembled on the thread during installation should not exceed 12 inch-pounds.

